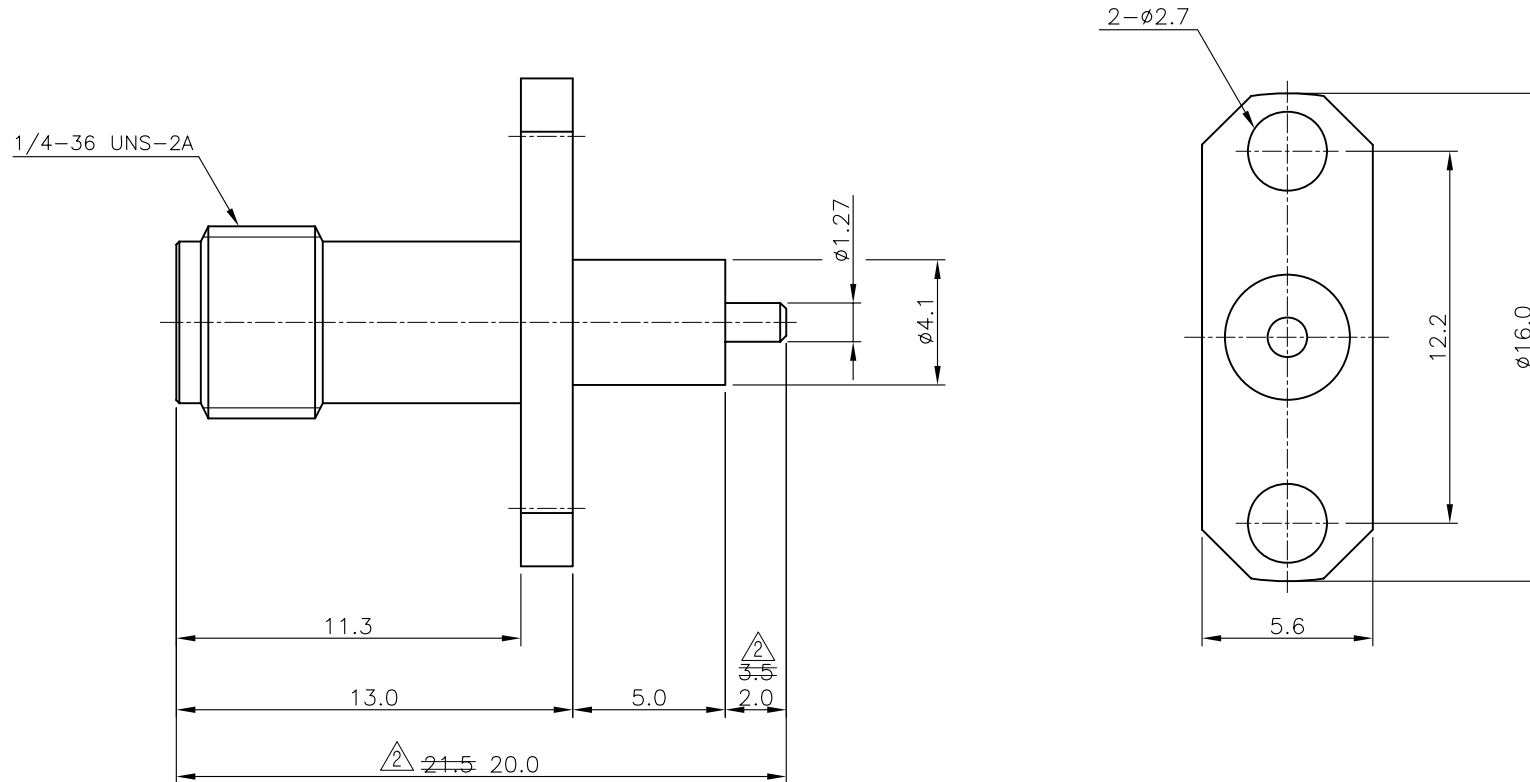


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013.03.18.
1	[설번No.201307-007]조립성 향상. 내경부 납시턱 추가 및 인슐레이터 변경.	M.H.SONG	I.C.KIM	2013.07.15.
2	[설번No.201310-0008] 업체요청 (핀 길이 변경)	E.H.KIM	I.C.KIM	2013.10.17.



3	INSULATOR	1	TEFLON		DIN02203-N/1 DIN00169-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02952-5/1 DCT02495-5/1
1	BODY	1	MBsBD	Gold Plate	DBD01708-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2013. 10. 17.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SMA50 SOLDER END JS-2H
		DRAWN BY	E.H.KIM	
FINISH		SCALE	UNIT	DWG NO. CN02957-7/1 REVISION 2 SHEET 1 of 1
		4/1	mm	